



ACE2310C

Plastic-Encapsulate MOSFET

Description

The ACE2310C uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltage as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

Features

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Applications

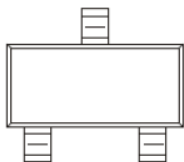
- Battery Switch
- DC/DC Converter

Absolute Maximum Ratings

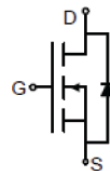
Parameter	Symbol	Max	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	3	A
Pulsed Drain Current (note 1)	I_{DM}	10	A
Power Dissipation	P_D	0.35	W
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	357	$^{\circ}C/W$
Junction Temperature	T_J	150	$^{\circ}C$
Storage Temperature	T_{STG}	-55~150	

Packaging Type

SOT-23-3

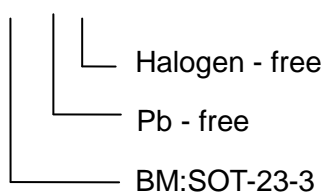


Equivalent Circuit



Ordering information

ACE2310C XX + H





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Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
STATIC CHARACTERISTICS						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	uA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate threshold voltage (note 3)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.5		2	V
Drain-source on-resistance (note 3)	R _{DS(on)}	V _{GS} =10V, I _D =3A			105	mΩ
		V _{GS} =4.5V, I _D =3A			125	
Forward tranconductance (note 3)	g ^{FS}	V _{DS} =15V, I _D =2A	1.4			S
Diode forward voltage (note 3)	V _{SD}	I _S =3A, V _{GS} = 0V			1.2	V
DYNAMIC CHARACTERISTICS (note 4)						
Input Capacitance	C _{iss}	V _{DS} =30V, V _{GS} =-0V F=1MHz		247		pF
Output Capacitance	C _{oss}			34		pF
Reverse Transfer Capacitance	C _{rss}			19.5		pF
SWITCHING CHARACTERISTICS (note 4)						
Turn-on delay time	t _{d(on)}	V _{GS} =-10V, V _{DD} =30V I _D =1.5, R _{GEN} =1Ω		6		ns
Turn-on rise time	t _r			15		
Turn-off delay time	t _{d(off)}			15		
Turn-off fall time	t _f			10		
Total Gate Charge	Q _g	V _{DS} =30V, V _{GS} =-4.5V, I _D =-3A		6		nC
Gate-Source Charge	Q _{gs}			1		
Gate-Drain Charge	Q _{gd}			1.3		

Note:

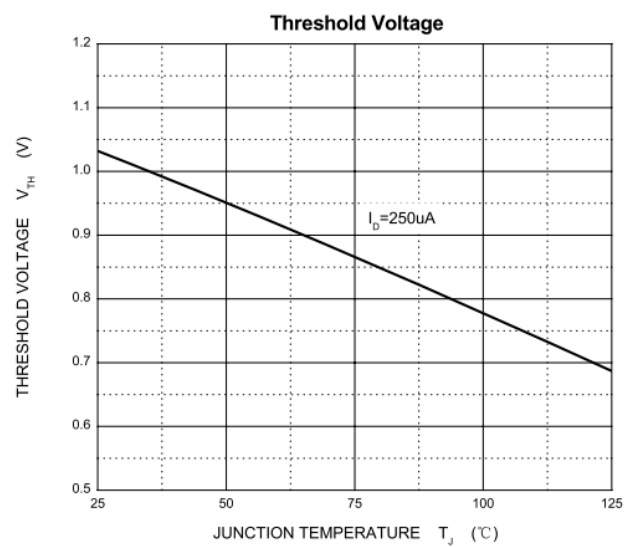
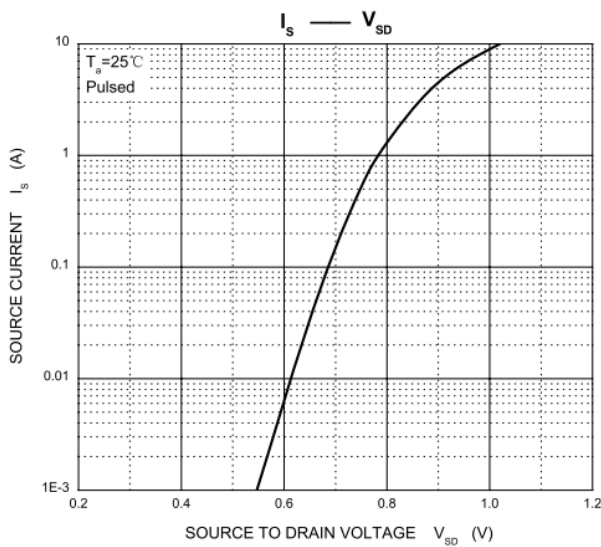
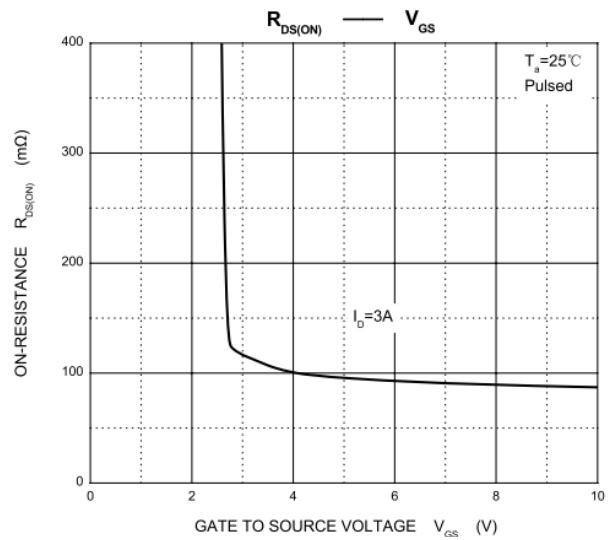
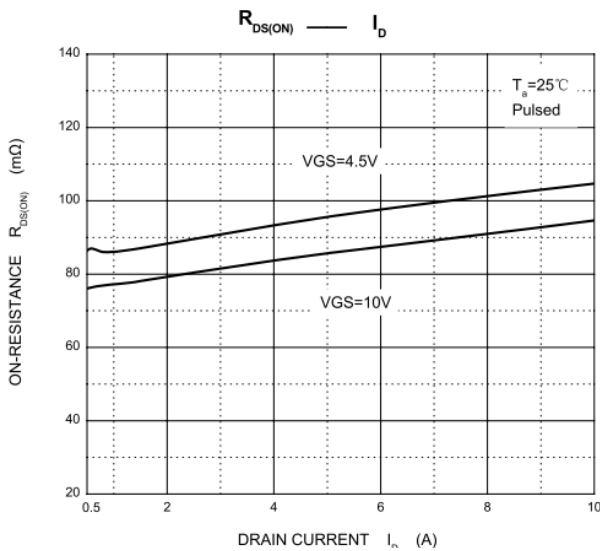
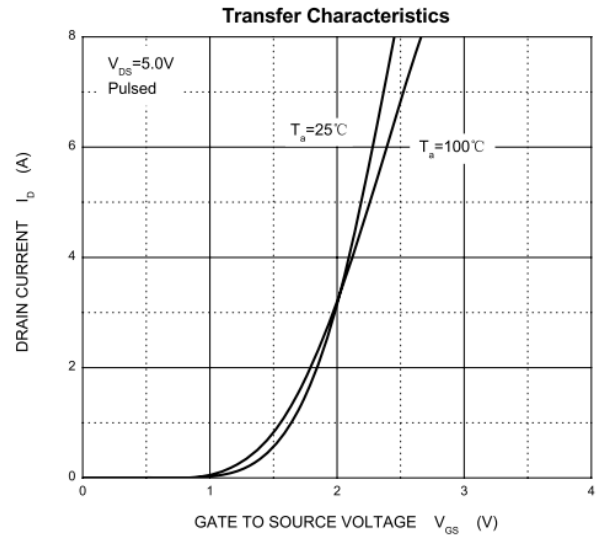
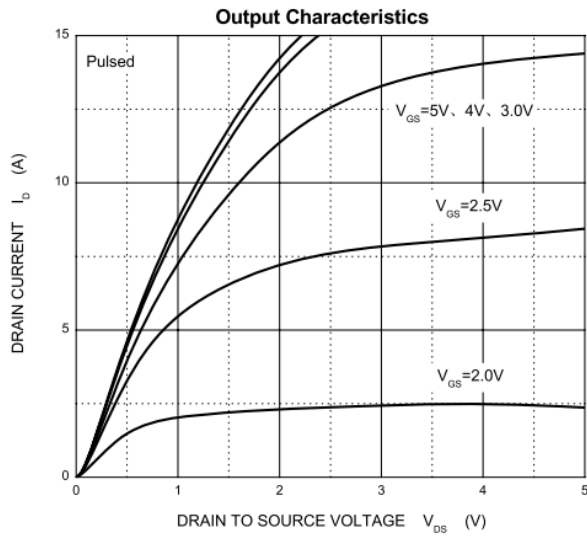
1. Repetitive rating : Pulse width limited by junction temperature.
2. Surface mounted on FR4 board , t_s≤10s.
3. Pulse Test : Pulse Width≤300μs, Duty Cycle≤0.5%.
4. Guaranteed by design, not subject to producing.



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Typical Performance Characteristics



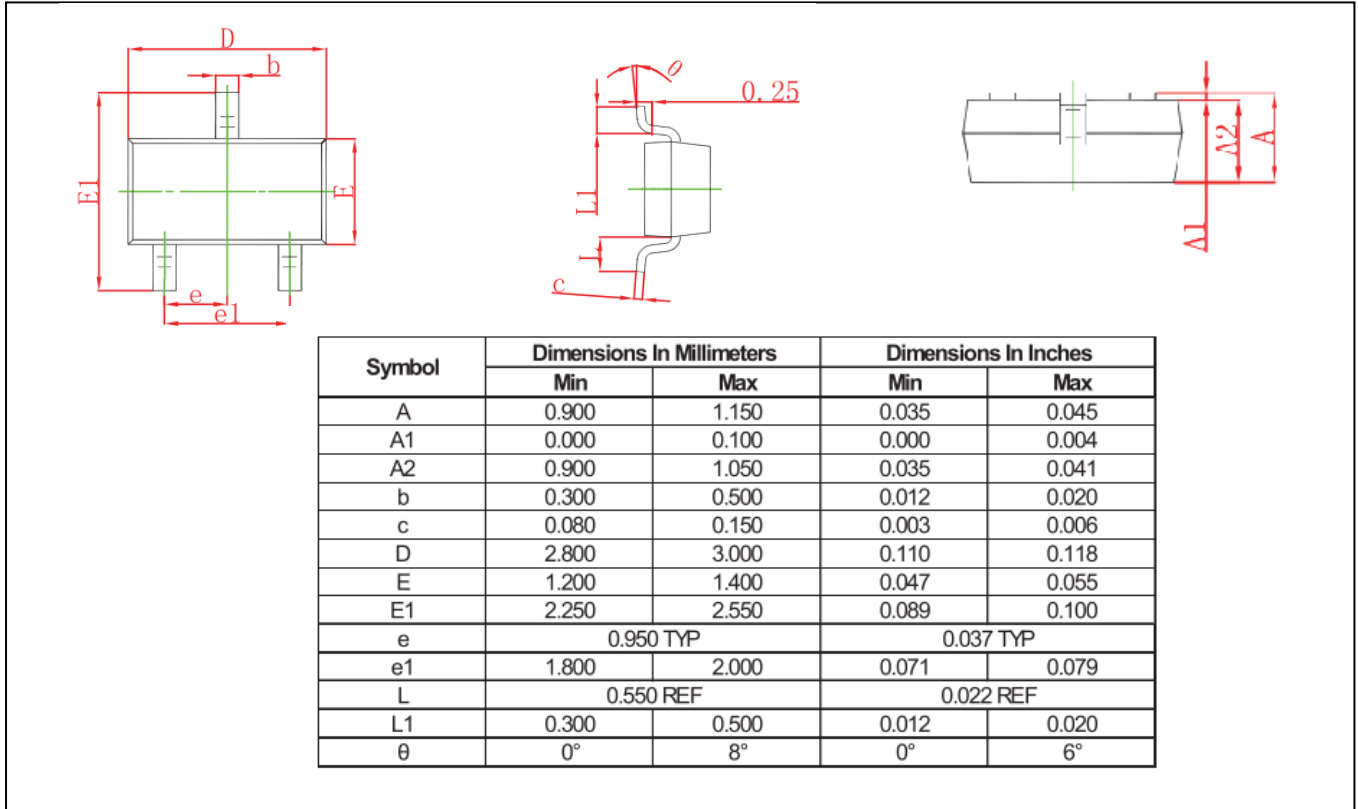


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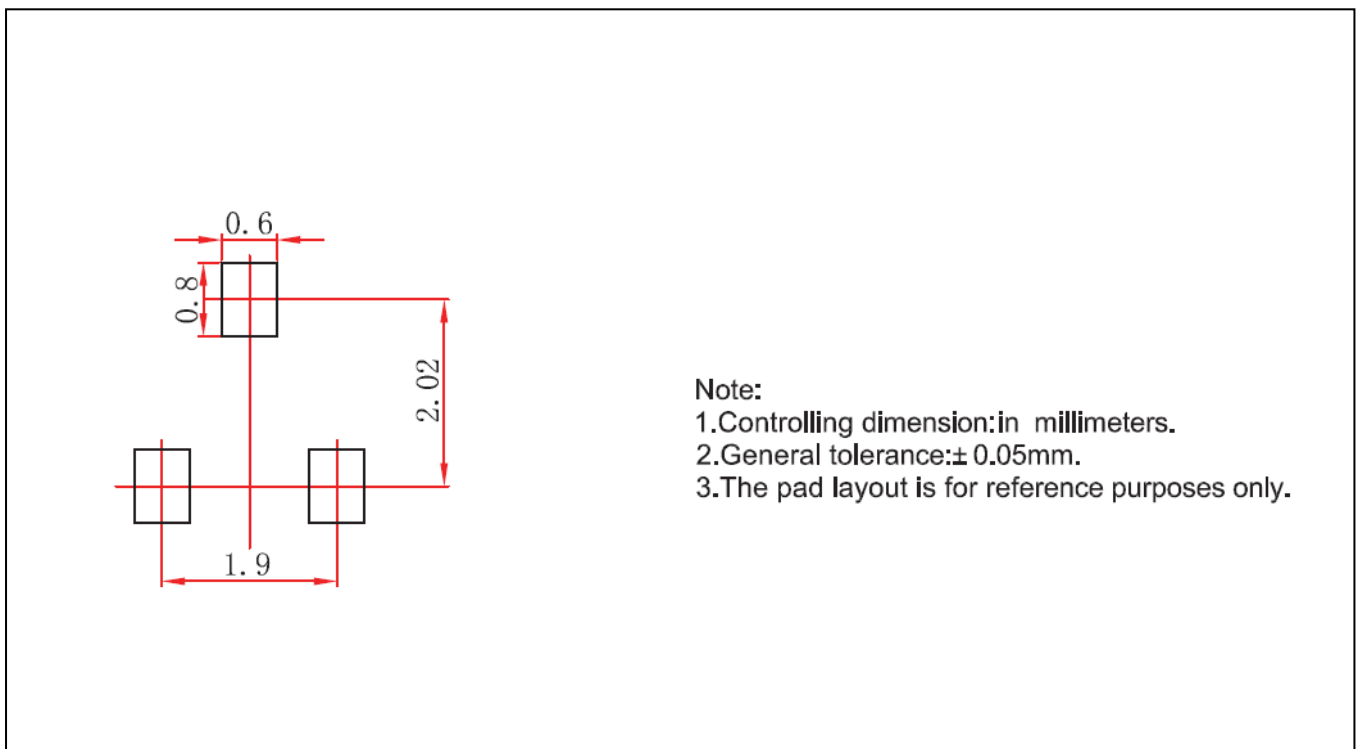
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Packing Information

SOT-23-3



SOT-23-3 Suggested Pad Layout



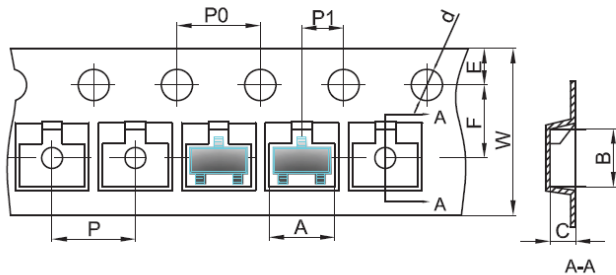


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SOT-23-3 Tape and Reel

SOT-23 Embossed Carrier Tape

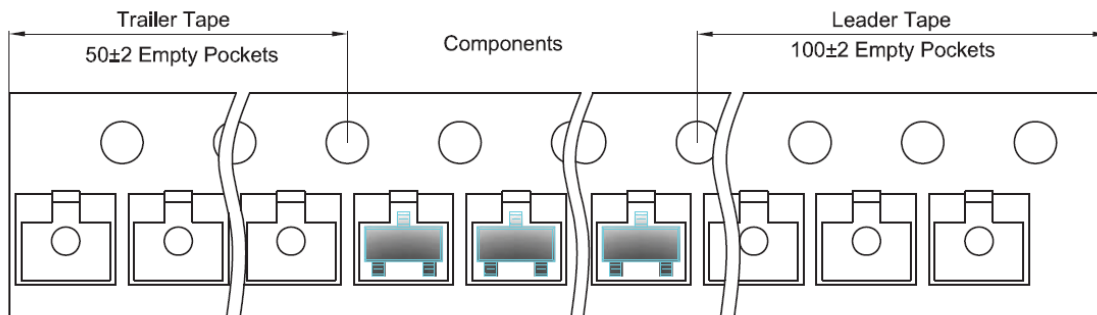


Packaging Description:

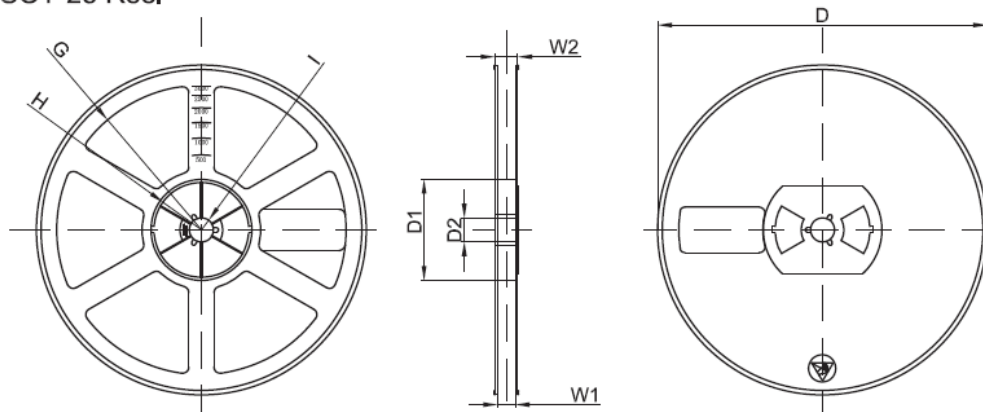
SOT-23 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 3,000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
SOT-23	3,15	2,77	1,22	Ø1,50	1,75	3,50	4,00	4,00	2,00	8,00
(Tolerance)	+/-0,1	+/-0,1	+/-0,1	+/-0,1	+/-0,1	+/-0,1	+/-0,1	+/-0,1	+/-0,1	+0,3/-0,1

SOT-23 Tape Leader and Trailer



SOT-23 Reel



Dimensions are in millimeter									
Reel Option	D	D1	D2	G	H	I	W1	W2	
7" Dia	Ø178,00	54,40	13,00	R78,00	R25,60	R6,50	9,50	12,30	
Tolerance	+/-2	+/-1	+/-1	+/-1	+/-1	+/-1	+/-1	+/-1	+/-1

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3000 pcs	7 Inch	45,000 pcs	203×203×195	180,000 pcs	438×438×220	



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Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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